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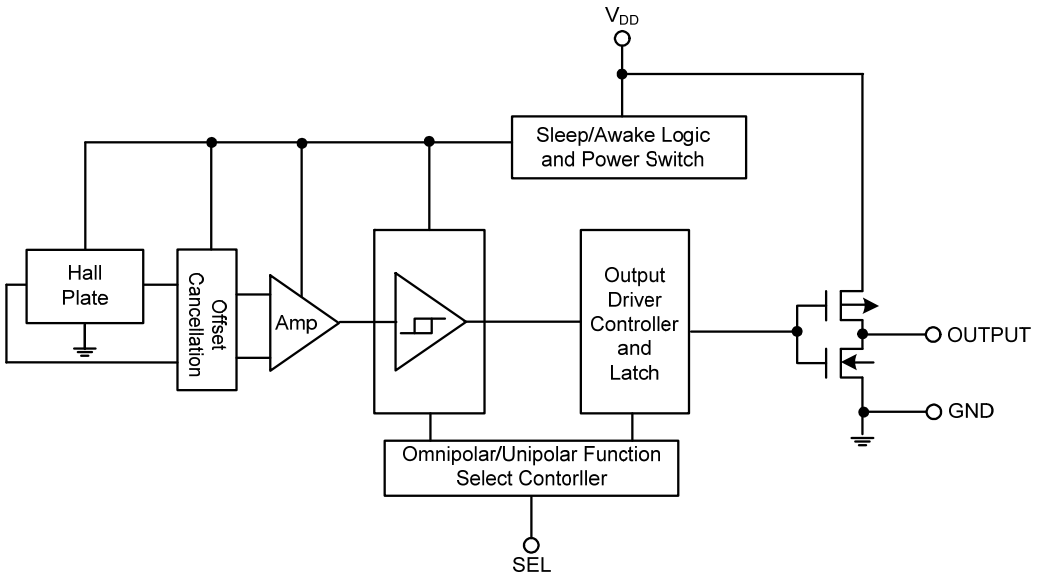
Pin Descriptions

Package: X1-DFN1216-4

Pin Number	Pin Name	Function
1	OUTPUT	Output Pin
2	GND	Ground Pin
3	SEL	Unipolar or Omnipolar Operation Select Pin; For Unipolar operation, pull-up the SEL pin to V_{DD} or leave it unconnected. The SEL pin is internally pulled high. For Omnipolar operation, connect the SEL pin to GND.
4	V_{DD}	Power Supply Input
Pad	Pad	The center exposed pad - It is internally connected to V_{DD} pin and should not be connected to GND or any other signal on the PCB. The exposed pad should be left open (unconnected) on the PCB layout.

Functional Block Diagram



Absolute Maximum Ratings (Note 5) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter		Rating	Unit
V_{DD}	Supply Voltage (Note 6)		6	V
V_{DD_REV}	Reverse Supply Voltage		-0.3	V
I_{OUTPUT}	Output current (source and sink)		3	mA
B	Magnetic Flux Density		Unlimited	
P_D	Package Power Dissipation	X1-DFN1216-4	230	mW
Ts	Storage Temperature Range		-65 to +150	°C
T_J	Maximum Junction Temperature		150	°C
ESD HBM	Human Body Model (HMB) ESD capability	V_{DD}, GND and OUTPUT pins	8	kV
		Logic SEL pin	6	kV

Notes:
5. Stresses greater than the 'Absolute Maximum Ratings' specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.
6. The absolute maximum V_{DD} of 6V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time.

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Recommended Operating Conditions (@T_A = +25°C, unless otherwise specified.)

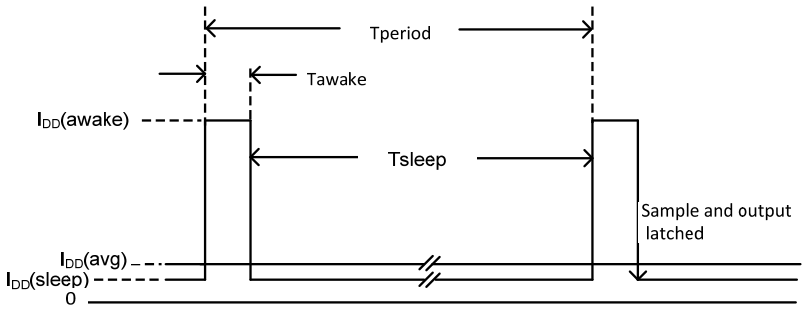
Symbol	Parameter	Conditions	Rating	Unit
V_{DD}	Supply Voltage	Operating	1.6V to 3.6V	V
T_A	Operating Temperature Range	Operating	-40 to +85	°C

Electrical Characteristics (@T_A = +25°C, V_{DD} = 1.8V, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{OL}	Output Low Voltage (on)	I_{OUT} = 1mA	—	0.1	0.2	V
V_{OH}	Output High Voltage (off)	I_{OUT} = -1mA	V_{DD} -0.2	V_{DD} -0.1	—	V
SEL Low	Omnipolar operation selected		0	—	0.5	V
SEL High	Unipolar operation selected		1.4	—	3.6	V
$R_{U\ SEL}$	BSEL pin internal pull-up resistor	(Note 7)	—	50		kΩ
Ioff	Output Leakage Current	V_{OUT} = 3.6V, Output off	—	< 0.1	1	μA
I_{DD}(awake)	Supply Current	During 'awake' period, T_A = +25°C, V_{DD} = 3V	—	2.1	—	mA
I_{DD}(sleep)		During 'sleep' period, T_A = +25°C, V_{DD} = 3V	—	2.5	—	μA
I_{DD}(avg)	Average Supply Current	T_A = +25°C, V_{DD} = 1.8V	—	4.3	8	μA
		T_A = +25°C, V_{DD} = 3.6V	—	7.2	13	μA
Tawake	Awake Time	(Note 8)	—	50	100	μs
Tperiod	Period	(Note 8)	—	50	100	ms
D.C.	Duty Cycle		—	0.1	—	%

Notes: 7. SEL pin internal pull-up resistor is only active during AWAKE time.
8. When power is initially on, the operating V_{DD} (1.6V to 3.6V) must be applied to guarantee the output sampling. The output state is valid after the second operating phase (typical 100ms).

Electrical Characteristics (cont.)



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Magnetic Characteristics (Notes 9 &10) (T_A = +25°C, V_{DD} = 1.8V, unless otherwise specified)

Unipolar Operation: SEL = High (> 1.4V to V_{DD} or No connection)

(1mT=10 Gauss)

Symbol	Characteristics	Test Condition	Min	Typ	Max	Unit
Bops (south pole to part marking side)	Operation Point		23	33	47	Gauss
		V_{DD} = 1.6V to 3.6V T_A = -40°C to +85°C	21	33	48	
Brps (south pole to part marking side)	Release Point		12	23	35	
		V_{DD} = 1.6V to 3.6V T_A = -40°C to +85°C	9	23	38	
Bhy (|Bopx|-|Brpx|)	Hysteresis		—	10	—	

Omnipolar Operation: SEL = Low (GND or <0.5V)

(1mT=10 Gauss)

Symbol	Characteristics	Test Condition	Min	Typ	Max	Unit
Bops (south pole to part marking side)	Operation Point		23	33	47	Gauss
		V_{DD} = 1.6V to 3.6V T_A = -40°C to +85°C	21	33	48	
Bopn (north pole to part marking side)			-47	-33	-23	
		V_{DD} = 1.6V to 3.6V T_A = -40°C to +85°C	-48	-33	-21	
Brps (south pole to part marking side)	Release Point		12	23	35	
		V_{DD} = 1.6V to 3.6V T_A = -40°C to +85°C	9	23	38	
Brpn (north pole to part marking side)			-35	-23	-12	
		V_{DD} = 1.6V to 3.6V T_A = -40°C to +85°C	-38	-23	-9	
Bhy (|Bopx|-|Brpx|)	Hysteresis		—	10	—	

Notes: 9. Typical data is at T_A = +25°C, V_{DD} = 1.8V.

10. Maximum and minimum parameters values over operating temperature range are not tested in production, they are guaranteed by design, characterization and process control. The magnetic characteristics may vary with supply voltage, operating temperature and after soldering.

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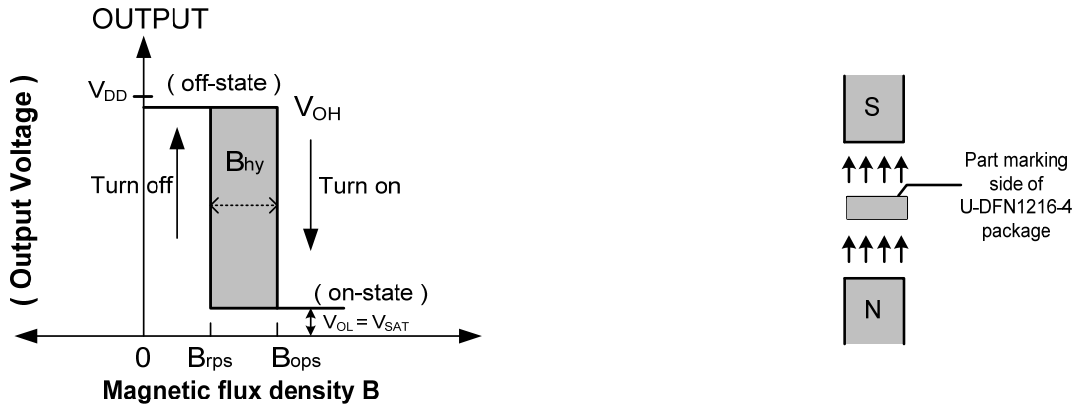
Application Notes

The AH1903 includes a Hall switch function select pin (SEL) so that the AH1903 can be changed between an Unipolar or an Omnipolar Hall Switch operation to fit a multitude of applications. The diagrams below show the different switching functions between the Unipolar and the Omnipolar Hall switch types.

AH1903 in Unipolar Operation

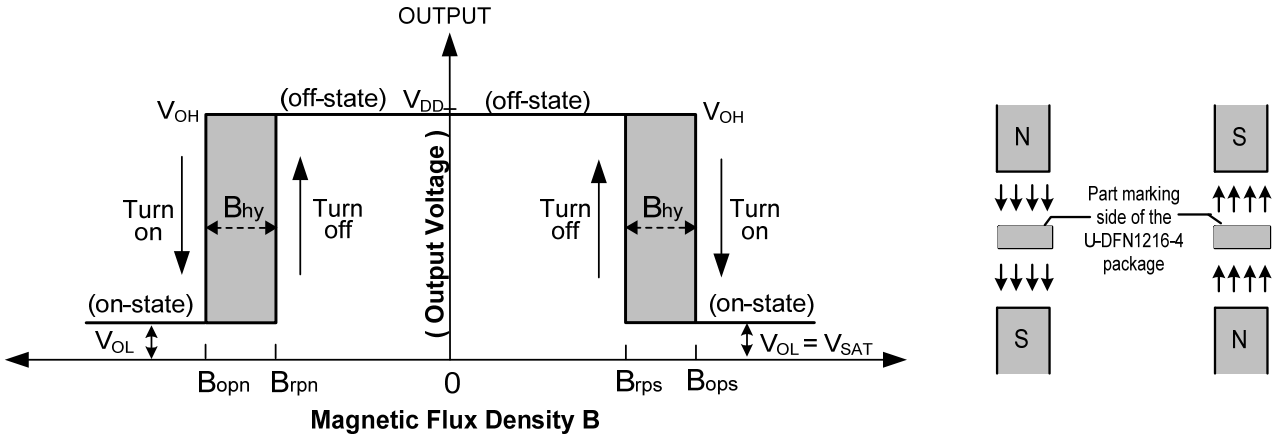
In Unipolar mode, the sensor detects the magnetic flux density perpendicular to the part marking surface with magnetic field direction only from the back to the front of the package as shown below. This magnetic field direction is similar to having a South pole on the part marking side or a North pole to the back of the package.



Magnetic Field Direction for Unipolar Mode Operation

AH1903 in Omnipolar Operation

In Omnipolar mode, the sensor detects the magnetic flux density perpendicular to the part marking surface with magnetic field directions from the front to the back as well as from the back to the front of the package as shown below. The sensor detects both North or South pole to the part marking side or to the back of the package.



Magnetic Field Directions for Omnipolar Mode Operation

The AH1903 includes a function select pin (SEL) to change the device type between Unipolar and Omnipolar operations. The SEL pin can be hard wired within the application circuit or can be changed on the fly by using the SEL pin as a logic input. This feature allows the AH1903 operating mode to be changed by firmware within the application without the addition of any external components. If the SEL pin is left open circuit the AH1903 defaults to Unipolar mode.

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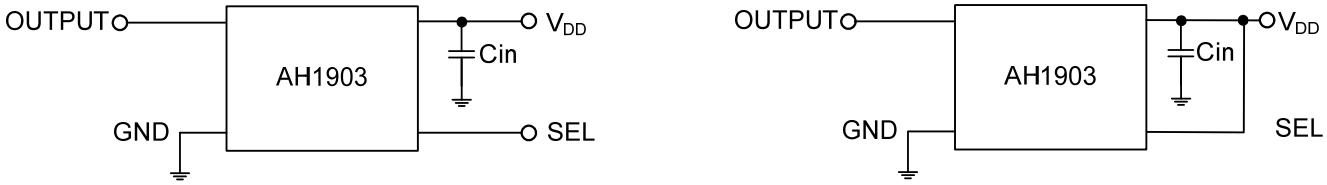
Application Notes (cont.)

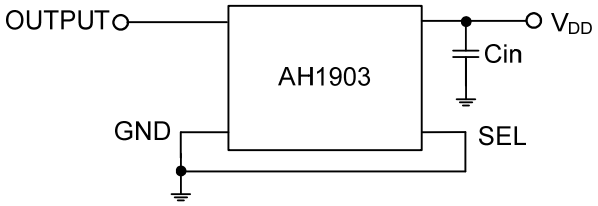
Applications Circuit 1 – Unipolar Operation

Connecting the SEL pin to V_{DD}, a voltage greater than 1.4V or leaving the SEL pin unconnected configures the AH1903 into Unipolar mode, only detecting South pole of sufficient strength from the part mark side of the package. In Unipoalr mode, North pole fields will not switch on the output.



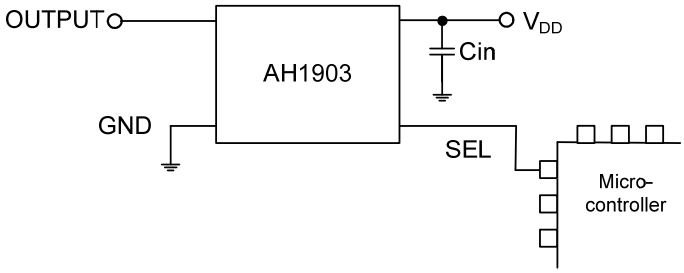
Applications Circuit 2 – Omnipolar Operation

Connecting the SEL pin to ground configures the AH1903 into Omnipolar mode, detecting both North and South magnetic fields of sufficient strength.



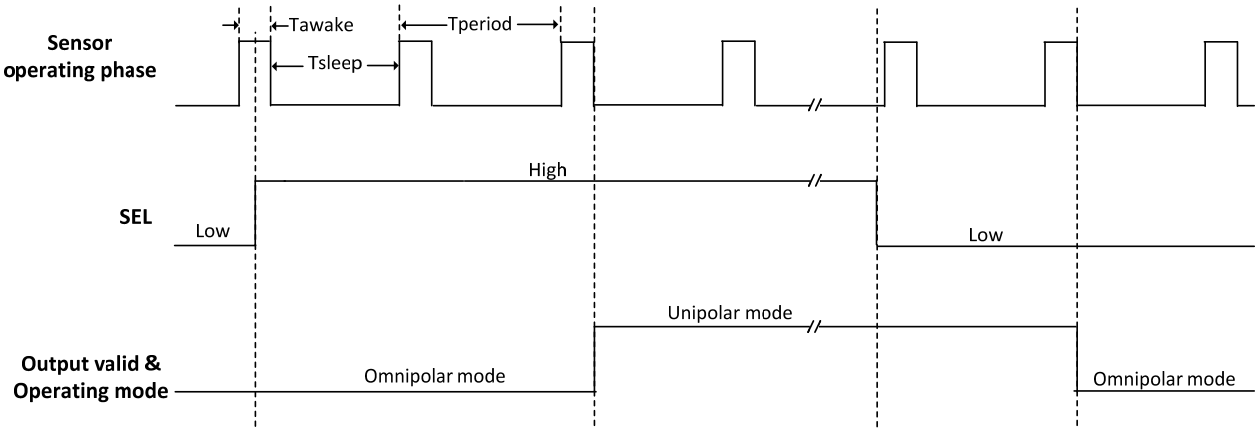
Applications Circuit 3 – Adjustable Sensor Type

To enhance flexibility within the application the sensor operation modes can be selected with a standard logic signal allowing it to be controlled by a micro-controller or a logic source. This allows the sensor type to be changed within the application without a hardware change. Whenever the Hall switch type is changed, the selection changeover should allow two awake period for the output to be valid.



Sensor Type Change Timing and Valid Output

Whenever type selection SEL pin input is changed, allow for band selection changeover to complete and stabilize. The output is valid only after the second complete operating 'awake' phase. Time taken for the output to be valid, after the SEL change, depends on timing of SEL change during the sleep and awake phase; this time can range from 100ms typical and 200.1ms maximum.



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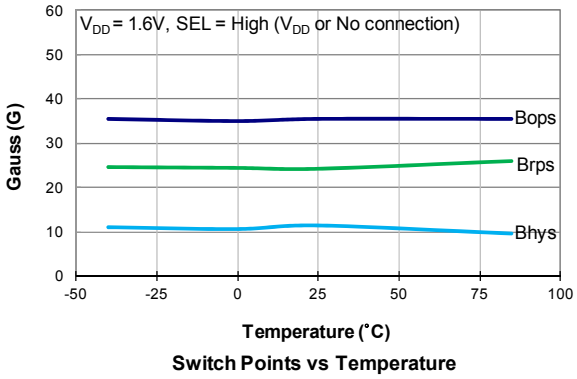
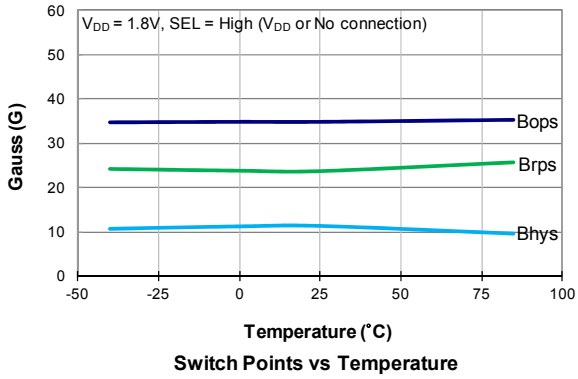
Typical Operating Characteristics

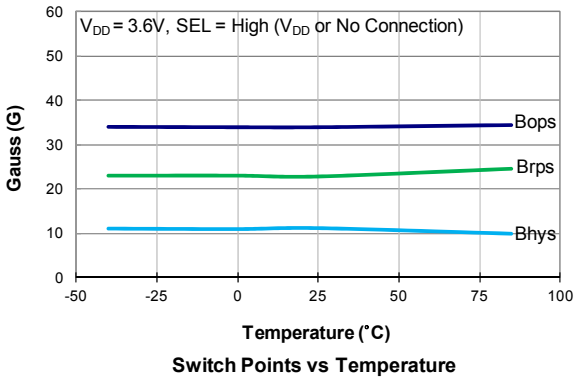
Operating Switch Points in Unipolar Operation (SEL = No connection or SEL = V_{DD})



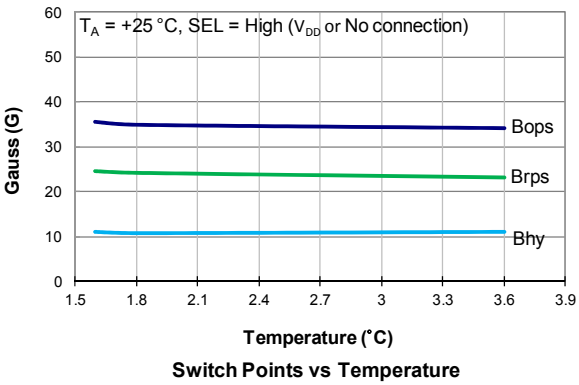
Switch Points vs Temperature



Switch Points vs Temperature



Switch Points vs Temperature



Switch Points vs Temperature

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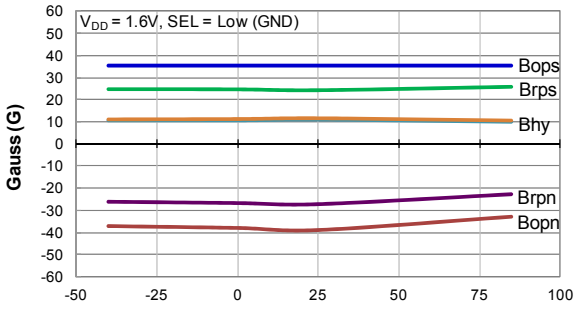
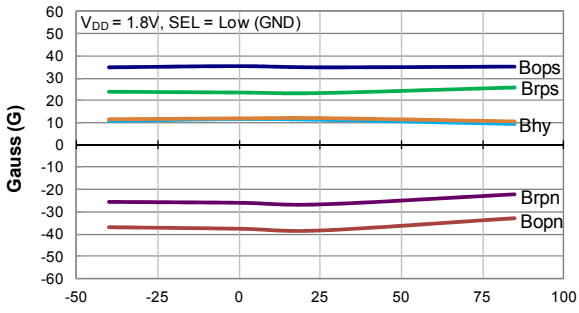
Typical Operating Characteristics (cont.)

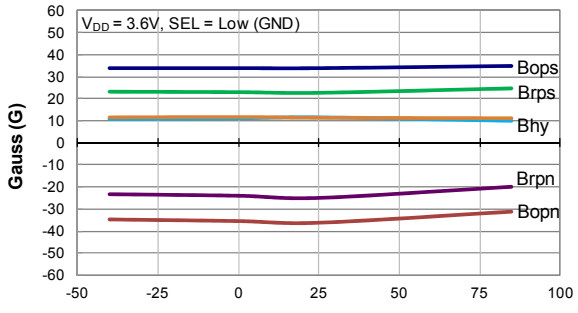
Operating Switch Points in Omnipolar Operation (SEL = GND)



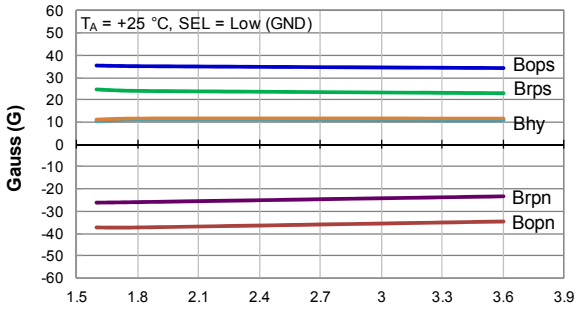
Switch Points vs Temperature



Switch Points vs Temperature

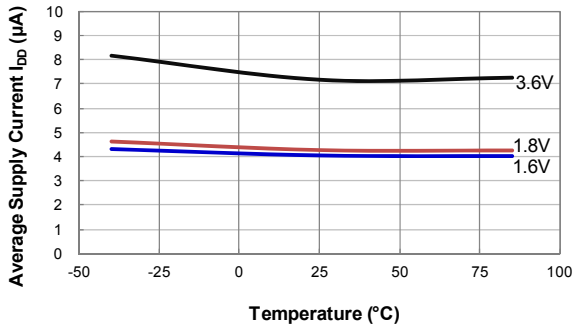


Switch Points vs Temperature

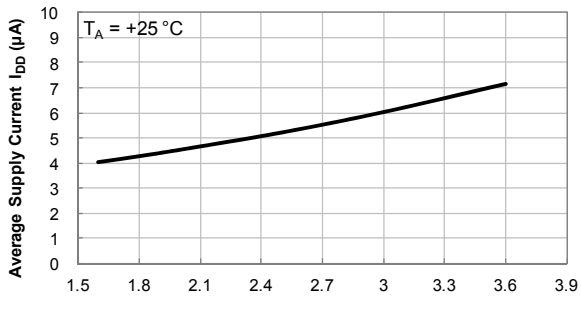


Switch Points vs Temperature

Average Supply Current - Unipolar or Omnipolar Operations



Average Supply Current vs. Temperature



Average Supply Current vs. Supply Voltage

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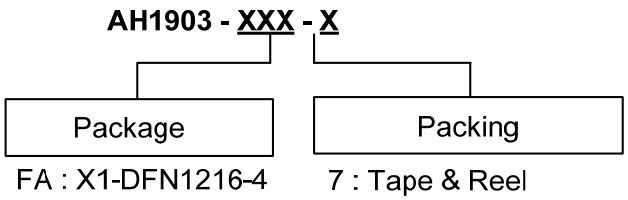
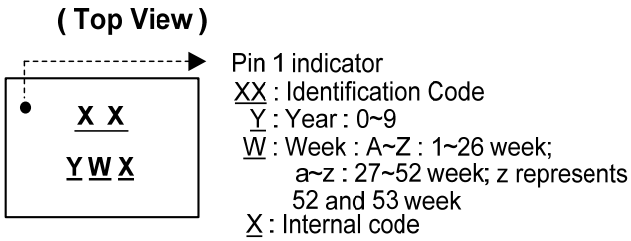
Ordering Information



Part Number	Package Code	Packaging	7" Tape and Reel	
			Quantity	Part Number Suffix
AH1903-FA-7	FA	X1-DFN1216-4	3000/Tape & Reel	-7

Marking Information

(1) Package Type: X1-DFN1216-4



Part Number	Package	Identification Code
AH1903-FA-7	X1-DFN1216-4	F3

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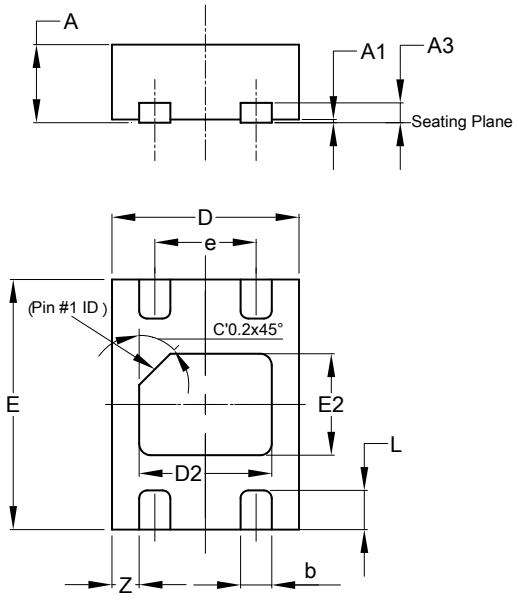
Package Outline Dimensions (All dimensions in mm.)

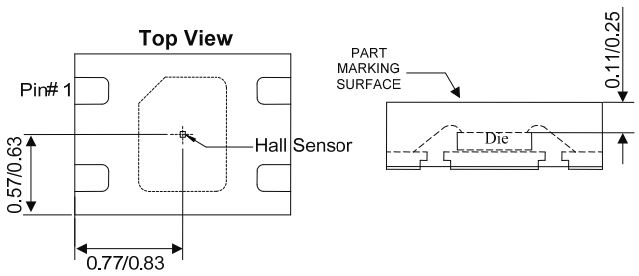
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

(1) Package Type: X1-DFN1216-4



Bottom View

X1-DFN1216-4			
Dim	**Min**	**Max**	**Typ**
A	0.47	0.53	0.50
A1	0.00	0.05	0.02
A3	--	--	0.13
b	0.15	0.25	0.20
D	1.15	1.25	1.20
D2	0.75	0.95	0.85
E	1.55	1.65	1.60
E2	0.55	0.75	0.65
e	-	-	0.65
L	0.20	0.30	0.25
Z	-	-	0.175
All Dimensions in mm			

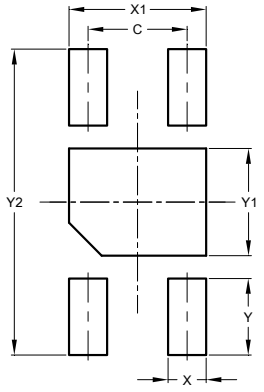


Sensor Location (To be confirmed)

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

(1) Package Type: X1-DFN1216-4



Dimensions	Value
C	0.65
X	0.25
X1	0.90
Y	0.50
Y1	0.70
Y2	2.00
All Dimensions in mm	

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